IEEE Xplore: Search Strategies to Optimize Your Research Time

何丹丹 Dan He
IEEE Client Services Manager
Agenda:

- Know about IEEE & IEEE Xplore
- Discover trending content
- Construct successful search strategies for precise results
- Stay current by setting-up saved search alerts and ToC alerts
- Get involved with IEEE activities and benefit your research and career
The IEEE History

1884 AIEE
American Institute of Electrical Engineers

1912 IRE
Institute of Radio Engineers

1963 IEEE
The Institute of Electrical and Electronics Engineers
Advancing Technologies for Humanity

Present
The IEEE Today

- World’s largest technical professional organization with approximately 400,000 members in over 160 countries
- Not for profit organization “Advancing Technology For Humanity”

- 300+ Sections in ten geographic Regions
- 2,000+ Chapters that unite local members with similar technical interests
- 3,000+ Student Branches in over 100 countries
39 IEEE Societies

IEEE Aerospace and Electronic Systems Society
IEEE Antennas and Propagation Society
IEEE Broadcast Technology Society
IEEE Circuits and Systems Society
IEEE Communications Society
IEEE Computational Intelligence Society
IEEE Computer Society
IEEE Consumer Electronics Society
IEEE Control Systems Society
IEEE Dielectrics and Electrical Insulation Society
IEEE Education Society
IEEE Electron Devices Society
IEEE Electronics Packaging Society
IEEE Electromagnetic Compatibility Society
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IEEE Instrumentation and Measurement Society
IEEE Intelligent Transportation Systems Society
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IEEE Microwave Theory and Techniques Society
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IEEE Oceanic Engineering Society
IEEE Photonics Society
IEEE Power Electronics Society
IEEE Power & Energy Society
IEEE Product Safety Engineering Society
IEEE Professional Communication Society
IEEE Reliability Society
IEEE Robotics and Automation Society
IEEE Signal Processing Society
IEEE Society on Social Implications of Technology
IEEE Solid-State Circuits Society
IEEE Systems, Man, and Cybernetics Society
IEEE Technology and Engineering Management Society
IEEE Ultrasonics, Ferroelectrics, and Frequency Control Society
IEEE Vehicular Technology Society
More than just electrical engineering & computer science

- Aerospace & Defense
- Automotive Engineering
- Biomedical Engineering
- Biometrics
- Circuits & Systems
- Cloud Computing
- Communications
- Computer Software
- Electronics
- Energy
- Engineering
- Imaging
- Information Technology
- Medical Devices
- Nanotechnology
- Optics
- Petroleum & Gas
- Power Electronics
- Power Systems
- Robotics & Automation
- Semiconductors
- Smart Grid
- Wireless Broadband
- and more
IEEE Quality Makes an Impact
Journal Citation Reports® by Impact Factor

IEEE publishes:

- 20 of the top 25 journals in Electrical and Electronic Engineering
- 9 of the top 10 journals in Telecommunications
- 5 of the top 5 journals in Automation & Control Systems
- 4 of the top 5 journals in Computer Science, Hardware & Architecture
- 3 of the top 5 journals in Computer Science, Artificial Intelligence
- 3 of the top 5 journals in Computer Science, Information Systems
- 3 of the top 5 journals in Computer Science, Software Engineering
- 3 of the top 5 journals in Computer Science, Cybernetics
- 3 of the top 5 journals in Imaging Science & Photographic Technology

Source: 2020 Journal Citation Reports (Clarivate Analytics, 2021)

Each year, the Journal Citation Reports® (JCR) from Web of Science Group examines the influence and impact of scholarly research journals. JCR reveals the relationships between citing and cited journals, offering a systematic, objective means to evaluate the world’s leading journals.

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The IEEE Conference Collection Continues to Grow

Over 1,800 annual conferences and 3.9 million total papers in IEEE Xplore
IEEE Conferences Continue to Address Growing Areas of Research in New and Emerging Technologies

IEEE conferences continue to address growing areas of research that transform our lives. Below are some examples of conferences published in 2021 covering these innovative technologies:

IEEE International Conference on **Acoustics, Speech and Signal Processing** (ICASSP)
IEEE International **Solid-State Circuits** Conference (ISSCC)
International Conference on **Artificial Intelligence and Big Data**
Annual SEMI **Advanced Semiconductor Manufacturing** Conference (ASMC)
International Conference on **Automation, Robotics and Applications** (ICARA)
IEEE International Conference on **Blockchain and Cryptocurrency** (ICBC)
IEEE International Conference on **Cyber Security and Cloud Computing** (CSCloud)
International Conference on **Ecological Vehicles and Renewable Energies** (EVER)
IEEE Power & Energy Society **Innovative Smart Grid Technologies** Conference (ISGT)
International Conference on **Internet of Things and Applications** (IoT)
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  - Available now

- **A Step-by-Step Approach to Designing Blockchain Solutions**
  - Available now

- **IEEE Software and Systems Engineering Standards Used in Aerospace and Defense**
  - Available now

- **Practical Applications of AR/VR Technology**
  - Planned Release: Q1 2022
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- IBM, MIT, AGU, URSI Journal
- (OA Journal): TUP, CSEE, CPSS, CES, CMP, BIAI, SAIEE
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- Morgan & Claypool, Now Publishers eBooks (Review Collections)
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- IEEE E-Learning Courses
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Login automatically via campus network
### Top Searches and Popular Content

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<thead>
<tr>
<th>Top Search Terms</th>
<th>Graphic</th>
<th>List</th>
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<tbody>
<tr>
<td>1. machine learning</td>
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<tr>
<td>2. IoT</td>
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<tr>
<td>3. Artificial Intelligence</td>
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<td>4. Image Processing</td>
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<td>5. Cloud Computing</td>
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<td>6. 5G</td>
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<tr>
<td>7. Deep Learning</td>
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<tr>
<td>8. Blockchain</td>
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<td>9. Antennas</td>
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<td>10. Data Mining</td>
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<td>11. Big Data</td>
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<td>12. VLSI</td>
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<td>13. UAV</td>
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<td>14. Smart Grid</td>
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<td>15. Face Recognition</td>
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<td>16. AI</td>
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<td>17. Edge Computing</td>
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<td>18. Cyber Security</td>
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<td>19. Object Detection</td>
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<td>20. GPU</td>
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<td>21. ISSCC</td>
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<tr>
<td>22. Reinforcement Learning</td>
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<tr>
<td>23. NOMA</td>
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<tr>
<td>24. 6G</td>
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<tr>
<td>25. Computer Vision</td>
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</tbody>
</table>

### Popular Content

<table>
<thead>
<tr>
<th>Popular Content</th>
<th>Journal and Magazine Articles</th>
<th>Conference Papers</th>
<th>Standards</th>
<th>Books</th>
</tr>
</thead>
<tbody>
<tr>
<td>All</td>
<td></td>
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</tbody>
</table>

**6G Wireless Systems: Vision, Requirements, Challenges, Insights, and Opportunities**
Proceedings of the IEEE
Harch Tataric; Mansoor Shafi; Andreas F. Molisch; Mischa Dohler; Henrik Sjöland; Fredrik Turvesson
Homepage: Search Upcoming Conferences
Global Search will search **METADATA ONLY**
- Search engine will automatically **AND** your words together
- Case insensitive and automatic stemming
- Searches for British and US spellings in English
- Use **quotation marks** around your term to force an exact phrase match e.g. “Wind energy conversion”
- Use **wildcards** for greater precision: *(for any or no characters), ?(for single character) e.g. Robot*
- Boolean, Proximity, and Field Searching allowed (operators MUST be in **ALL CAPS**)

Support for Advanced Searchers: Global Search
Advanced Search: Search by Fields

Enter keywords and select fields:

- All Metadata

Publication Year

- Documents Added Between: 08/01/2021 and 09/08/2021
- Specify Year Range:
  - 1884
  - 2022
Command Search

Advanced Search

Enter keywords, phrases, or a Boolean expression
Use the drop down lists to choose Data Fields and Operators. Learn how to use Boolean expressions in Command Search.

Operators need to be in all caps - i.e. AND/OR/NOT/NEAR/ONEAR. There is a maximum of 20 search terms.

Search Expression Examples

"Full Text Only":app* NEAR/5 "Full Text Only":secur* AND "Author Affiliations":Apple
### Search Results and Refinements

Showing 1-25 of 56,801 for MOSFETx

- Conferences (40,824)
- Journals (15,440)
- Magazines (275)
- Books (137)
- Early Access Articles (120)
- Standards (3)
- Courses (2)

**Publications You May Be Interested In**

<table>
<thead>
<tr>
<th>Author</th>
<th>Affiliation</th>
<th>Publication Title</th>
<th>Publication Topics</th>
</tr>
</thead>
<tbody>
<tr>
<td>Chemming Hu (370)</td>
<td>IMEC, Leuven, Belgium (272)</td>
<td>IEEE Transactions on Electron Devices</td>
<td>MOSFET (26,397)</td>
</tr>
<tr>
<td>S. Cristoloveanu (206)</td>
<td>Dept. of Electron. Eng., Nat. Chiao Tung Univ., Hsinchu, Taiwan (180)</td>
<td>IEEE Transactions on Nuclear Science (1,053)</td>
<td>CMOS integrated circuits (7,093)</td>
</tr>
<tr>
<td>G. Groeseneken (203)</td>
<td>imec, Leuven, Belgium (134)</td>
<td>IEEE Transactions on Power Electronics (931)</td>
<td>power MOSFET (5,687)</td>
</tr>
<tr>
<td>E. Simoen (186)</td>
<td>IBM Thomas J. Watson Res. Center, Yorktown Heights, NY, USA (127)</td>
<td>IEEE Transactions on Device and Materials Reliability (330)</td>
<td>silicon compounds (5,200)</td>
</tr>
<tr>
<td>Yee-Chia Yeo (181)</td>
<td>STMicroelectronics, Crolles, France (120)</td>
<td>IEEE Journal of Solid-State Circuits (988)</td>
<td>silicon (4,785)</td>
</tr>
<tr>
<td>Bo Zhang (178)</td>
<td></td>
<td>IEEE Transactions on Device and Materials Reliability (330)</td>
<td>silicon-on-insulator (4,521)</td>
</tr>
<tr>
<td>Ru Huang (176)</td>
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<td></td>
<td>elemental semiconductors (4,450)</td>
</tr>
<tr>
<td>C. Clayes (163)</td>
<td></td>
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<td>wide band gap semiconductors (4,122)</td>
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<tr>
<td>N. Colael (162)</td>
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</tbody>
</table>
Search Results and Refinements

Showing 1-25 of 55,597 for "Metal Oxide Semiconductor Field Effect Transistor" OR MOSFET

- Conferences (39,998)
- Journals (15,043)
- Magazines (266)
- Books (137)
- Standards (3)
- Courses (2)

Show
- All Results
- Open Access Only

Sort By: Relevance
- Relevance
- Newest First
- Oldest First
- Most Cited [By Papers]
- Most Cited [By Patents]
- Most Popular
- Publication Title A-Z
- Publication Title Z-A

Enhanced Electrical and Thermal Properties of Trench Metal-Oxide-Semiconductor Field-Effect Transistor Built on Copper Substrate
Qi Wang; Ihsiu Ho; Minhua Li
IEEE Electron Device Letters
Year: 2009 | Volume: 30, Issue: 1 | Journal Article | Publisher:
Cited by: Papers (8) | Patents (7)

Abstract

Fabrication and Characterization of a Metal Oxide Semiconductor Field Effect Transistor (MOSFET)-based Micro pH Sensor
Hybrid MOSFET/driver for ultra-fast switching

T. Tang, C. Burkhardt

IEEE Transactions on Dielectrics and Electrical Insulation
Year: 2009 | Volume: 16, Issue: 4 | Journal Article | Publisher: IEEE
Cited by: Papers (0)

Coverage: 1311
Full Text Views: 8

Abstract:
The ultra-fast switching of power MOSFETs, in about 1 ns, is very challenging. This is largely due to the parasitic inductance that is intrinsic to commercial packages used for both MOSFETs and drivers. Parasitic gate and source inductance not only limit the voltage rise time on the MOSFET internal gate structure but can also cause the gate voltage to oscillate. This paper describes a hybrid approach that substantially reduces the parasitic inductance between the driver and MOSFET gate, as well as between the MOSFET source and its external connection. A flip-chip assembly is used to directly attach a die-form power MOSFET and driver on a PCB. The parasitic inductances are significantly reduced by eliminating bond wires and minimizing lead length. The experimental results demonstrate ultra-fast switching of the power MOSFET with excellent control of the gate-source voltage.

Published in: IEEE Transactions on Dielectrics and Electrical Insulation (Volume: 16, Issue: 4, August 2009)

Page(s): 967 - 970
Date of Publication: 28 August 2009
DOI: 10.1109/TDEI.2009.5211841
INSPEC Accession Number: 10847239
ISSN Information:

SECTION I. Introduction

Power MOSFETs have great potential as switches for high speed high voltage applications like pulsed power, the theoretical carrier transit time from drain to source is on the order of 200 ps in any cell of the silicon die [1]. Although the power MOSFET
Chenming Hu (F’03) is the TSMC Distinguished Professor Emeritus of University of California Berkeley, Berkeley, CA, USA. He is a former Chief Technology Officer of TSMC. He is a Board Director of SanDisk Inc., and of the non-profit Friends of Children with Special Needs. He is well known for his work on the 3-D transistor, FinFET, which can be scaled to single digit nanometers. He has developed widely used IC reliability models and led the research of BSIM—the first industry-standard SPICE model used by most IC companies to design CMOS products since 1996. He was a recipient of the IEEE Andrew Grove Award, the Solid State Circuits Award and Nishizawa Medal, the Kaufman Award of the EDA industry, the University Research Award of the U.S. Semiconductor Industry Association, and the UC Berkeley’s Highest Honor for teaching—the Berkeley Distinguished Teaching Award.
Chenming Hu

Also published under: C. Hu

Affiliation
University of California Berkeley, Berkeley, U.S.A.

Publication Topics
MOSFET, semiconductor device models, semiconductor doping, III-V semiconductors, elemental semiconductors, CMOS integrated circuits, field effect transistors, gallium compounds, indium compounds, low-power electronics, molybdenum

Biography
Chenming Hu (F’90) received the Ph.D. degree in electrical engineering from the University of California (UC) at Berkeley, Berkeley, CA, USA. He is TSMC Distinguished Professor Emeritus with UC Berkeley. He is the 2020 IEEE Medal of Honor recipient and has received the US National Medal of Technology and Innovation from President Obama in 2016 for developing transistor compact models BISM, first 3D transistor FinFET, and semiconductor reliability physics.

Co-Authors:
M. Abu-Rahma
Amit Agarwal
H. Agarwal
Jong-Ho Bae
Kaiman Chan

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Chenming Hu: 2020 IEEE Medal of Honor Award Recipient

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This is the supplementary file of the article “A Voting-Mechanism based Ensemble Framework for Constraint Handling Techniques” published in IEEE Transactions on Evolutionary Computation. This file contains two parts. One part includes the details of the 57 real-world constrained optimization problems, which are used in Section IV in the manuscript. Another part is the experimental results, including the best/mean/median values of the ten comparison algorithms on the 57 real-world constrained optimization problems, as the supplementary data of Table I and Table II in the manuscript.
Find Code, Multimedia, and Datasets
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Personalized Channel Recommendation Deep Learning From a Switch Sequence
Can Yang, Sixuan Ren, Yong Liu, Houwei Cao, Qihu Yuan, Guoqiang Han
IEEE Access
Year: 2018, Volume: 6
Page(s): 50824 - 50838
IEEE Journals & Magazines

Supplemental Items

- Media (36,317)
- Video (897)
- Datasets (451)
- Code (356)

Conference Location

Abstract:
This dataset includes the Channels Switch Sequences of 300 IPTV viewers in Guangzhou, P.R. China, in August, 2014. There are 4 columns in the file, which represent viewer ID, the current channel number, the next channel number, and the date of the month, respectively. The first column, the ID code of a viewer, ranks in descent with the times the viewer watched tv channels. The more times a viewer watches tv channels, the bigger the ID is. In a day, the rows are time series and generated step by step as the real watching tv behavior.

DATASET FILES
- IPTVChannelSwitchSequencesUsers300.dat (3.31 MB)

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Optimal microgrids placement in electric distribution systems using complex network framework
Mahmoud Saleh; Yusef Esa; NWabueza Onuorah; Ahmed A. Mohamed
2017 IEEE 8th International Conference on Renewable Energy Research and Applications (ICRERA)
Year: 2017
Page: 1036 - 1040
Cited by: Papers (2)
IEEE Conferences
• Abstract (html)
• (880 Ks)
• Code

Code & Datasets

This article contains code hosted on IEEE's partner, Code Ocean, a cloud-based computational reproducibility platform that enables users to run, modify, and download code from IEEE Xplore articles. A Code Ocean user account is required to run and modify code within the widget below.

Code: Applications of Complex Network Analysis in Electric Power Systems
MATLAB

Applications of Complex Network ... (Mahmou... )

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Edit Capsule
Sign up

July 17, 2018
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Practical Applications of Virtual and Augmented Reality in Business and Society: The Case of Gaming
Nicholas Napp
Year: 2021 | Course Code: C001
Abstract: This course explores the integration of virtual and augmented reality technologies in business and society, focusing on the case of gaming. It covers the latest developments in the field, including technological advancements and their impact on the gaming industry.

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In this course, we look at the impact of video games on the evolution of real-world intelligent and immersive realities. From humble, niche beginnings, video games have grown to become a $160 Billion industry impacting the lives of billions of people...

CEUs: 0.3  
PDHs: 3  
1 Hour

Introductory
IoT Software: Fundamental Concepts and State of the Art

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https://r10.ieee.org/hk/
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- Zhejiang Lab
- IBM
- Tencent
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  - IEEE Charles LeGeyt Fortescue Fellowship
  - IEEE Computational Intelligence Society Conference Travel Grants
  - IEEE Computational Intelligence Society Summer Research Grant
  - IEEE Components, Packaging, and Manufacturing Technology Society Graduate Fellowship for Research on Electronic Packaging
  - IEEE Computer Society Merwin Scholarship
  - IEEE Dielectrics and Electrical Insulation Society Graduate Student
  - IEEE Electron Devices Society Graduate Student Fellowship
  - ......

- IEEE Competitions
  - Presidents' Change the World Competition
  - IEEE Computer Society Simulator Design Competition
  - Student paper contest
  - ......
Exciting Contests!

IEEE Xtreme Programming Challenge

- [https://ieeextreme.org](https://ieeextreme.org)
- Worldwide, 24-hour programming challenge for IEEE Student and Graduate Student Members
- Teams advised and proctored by an IEEE Member, compete in 24-hour time span to solve a set of programming challenges

Formula Hybrid

- Competition founded by Thayer School of Engineering at Dartmouth
- Held at New Hampshire Motor Speedway
- Open to undergraduates and graduates
- Build and compete with an electric or hybrid racecar
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Upcoming SSCS Webinar

An Organic-Photoconductive-Film CMOS Image Sensor’s Advanced Technologies

Presented by Kazuko Nishimura
Panasonic Corporation
Friday, May 21st, 9:00 AM ET
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何丹丹 Dan He
IEEE Client Services Manager
d.he@ieee.org

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IEEE *Xplore* Team in Hong Kong
info.hk@igroupnet.com
Thank you